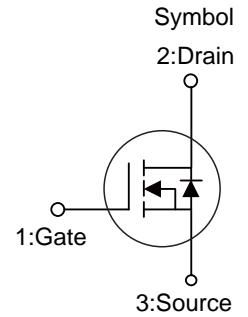


■ PRODUCT CHARACTERISTICS

V_{DSS}	800V
$R_{DS(ON)}$ Typ(@ $V_{GS}=15V$)	580m Ω
Q_g @typ	19nC
I_D	7A

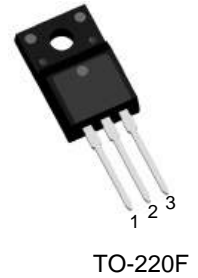


■ APPLICATIONS

- *Switch Mode Power Supplies
- *High Voltage DC/DC Converters
- *Battery Chargers
- *Motor Drivers

■ FEATURE

- *Low On-Resistance With High Blocking Voltage
- *Low Capacitances With High -Speed Switching
- *Low Reverse Recovery(Qrr)
- *Easy to Parallel and Simple to Drive



■ ORDER INFORMATION

Order Codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT80CH550F	TO-220F	50 pieces/Tube

■ ABSOLUTE MAXIMUM RATINGS($T_A=25^{\circ}C$, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DSS}	800	V
Gate-Source Voltage	V_{GSS}	-10/+22	V
Recommended Operation Voltage Of Gate to Source	V_{GSOP}	0/+18	V
Drain Current Continuous(@ $V_{GS}=15V, T_C=25^{\circ}C$)	I_D	7	A
Drain Current Continuous(@ $V_{GS}=15V, T_C=175^{\circ}C$)	I_D	5	A
Drain Current Pulsed(@ $V_{GS}=15V, T_C=25^{\circ}C$)	I_{DM}	14	A
Power Dissipation	P_D	30	W
Junction Temperature	T_J	+175	$^{\circ}C$
Storage Temperature	T_{STG}	-55~ +175	$^{\circ}C$

■ THERMAL CHARACTERISTICS

Parameter	Symbol	Typ	Unit
Junction to Case	R_{thJC}	5	$^{\circ}C/W$

■ ELECTRICAL CHARACTERISTICS ($T_C=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain to Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V, I_D=500\mu A$	800	-	-	V
Drain to Source Leakage Current	I_{DSS}	$V_{DS}=800V, V_{GS}=0V$	-	-	10	μA
Gate to Source Forward Leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=18V$	-	-	250	nA
On characteristics						
Drain to Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=15V, I_D=3.6A$	-	580	700	m Ω
		$V_{GS}=15V, I_D=3.6A, T_j=175^{\circ}\text{C}$	-	490	-	m Ω
		$V_{GS}=18V, I_D=3.6A$	-	400	-	m Ω
		$V_{GS}=18V, I_D=3.6A, T_j=175^{\circ}\text{C}$	-	450	-	m Ω
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=1.3mA$	2.7	3.6	4.5	V
Dynamic characteristics						
Gate capacitance	R_g	$V_{AC}=25mV, f=1.0MHz$	-	5	-	Ω
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V$ $f=1.0MHz$	-	196	-	pF
Output Capacitance	C_{oss}		-	43	-	pF
Reverse Transfer Capacitance	C_{rss}		-	2.7	-	pF
Resistive Switching Characteristics						
Turn-on Delay Time	$t_{d(ON)}$	$I_D=3.6A, V_{DS}=500V$ $R_G=10\Omega, V_{GS}=0/15V$	-	15	-	ns
Rise Time	t_r		-	39	-	ns
Turn-off Delay Time	$t_{d(OFF)}$		-	16	-	ns
Fall Time	t_f		-	69	-	ns
Total Gate Charge	Q_g	$I_D=3.6A, V_{DS}=500V$ $V_{GS}=0/15V$	-	19	-	nC
Gate to Source Charge	Q_{gs}		-	5.4	-	nC
Gate to Drain("Miller") Charge	Q_{gd}		-	9.5	-	nC
Source-Drain Diode Characteristics						
Continuous Source Current(Body Diode)	I_s		-	-	7	A
Diode Forward Voltage	V_{SD}	$I_{SD}=2.1A, V_{GS}=0V$	-	4	-	V
Reverse Recovery Time	t_{rr}	$I_{SD}=3.6A, T_j=25^{\circ}\text{C}$ $di/dt=530A/\mu s$	-	11	-	ns
Reverse Recovery Charge	Q_{rr}		-	31	-	nC

■ TYPICAL CHARACTERISTICS(Cont.)

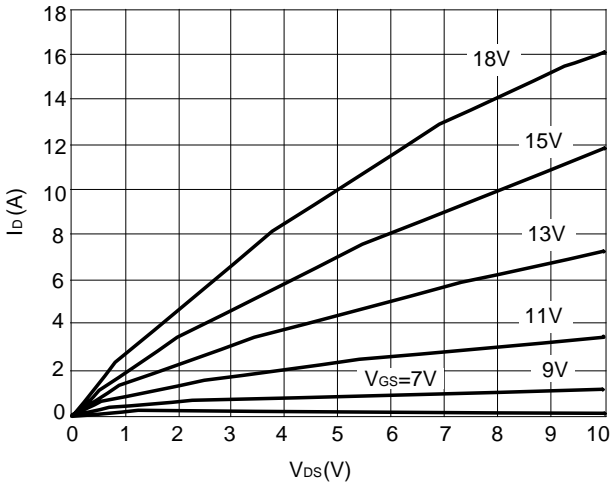


Figure 1: Output Characteristics($T_J=25^\circ\text{C}$)

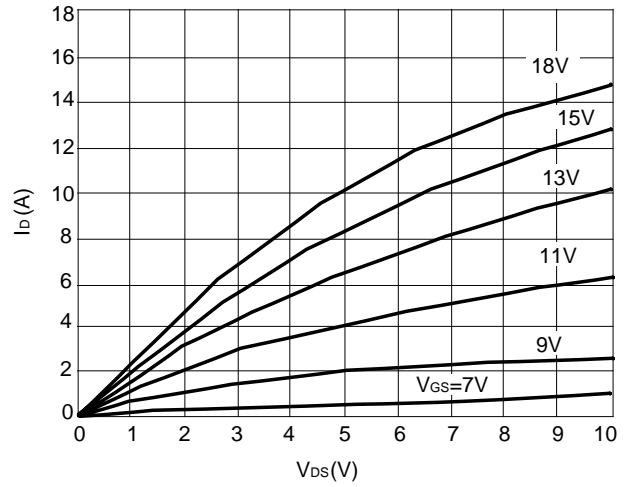


Figure 2: Output Characteristics($T_J=175^\circ\text{C}$)

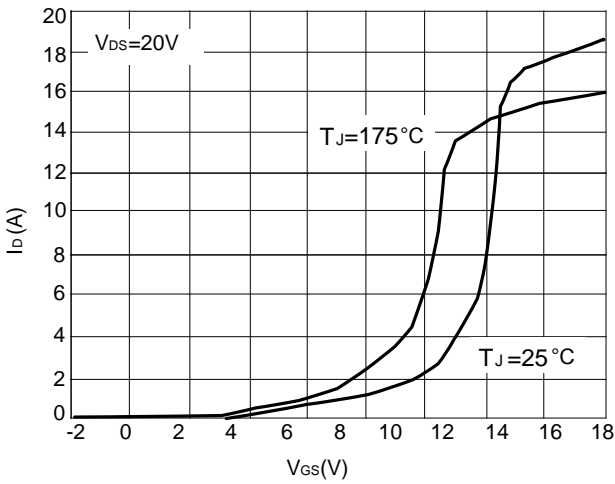


Figure 3: Typical Transfer Characteristics

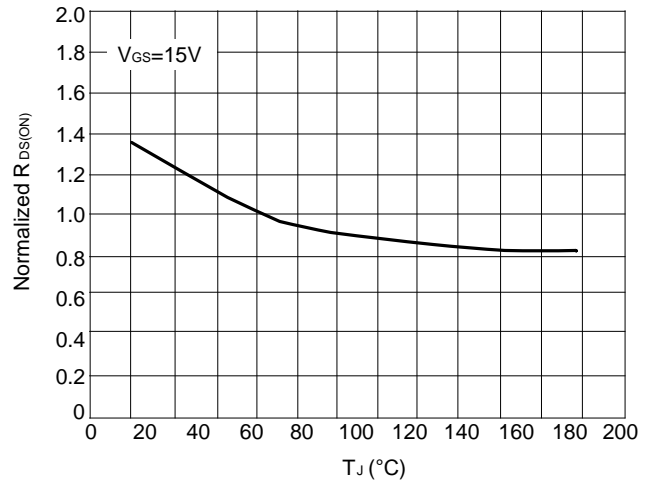


Figure 4: Normalized On-Resistance vs Temperature

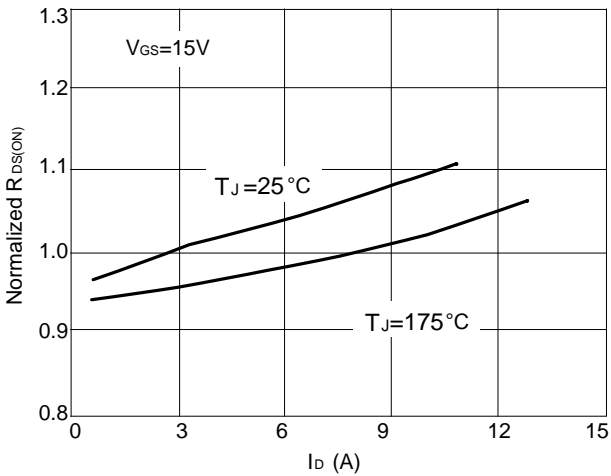


Figure 5: Normalized On-Resistance vs. Drain Current For Various Temperature

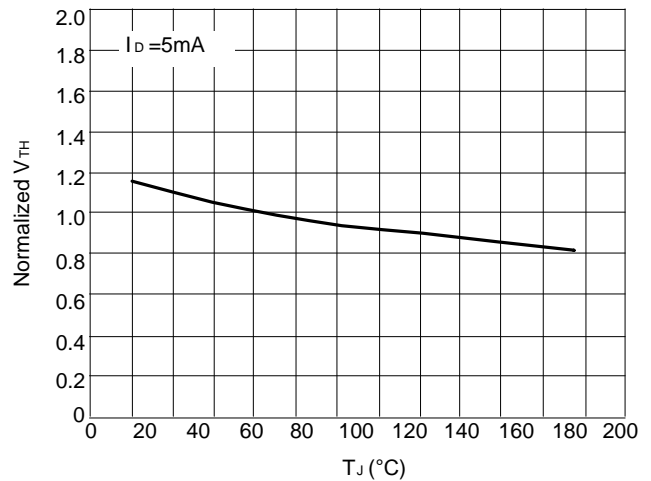


Figure 6: Normalized Threshold Voltage vs. Temperature

■ TYPICAL CHARACTERISTICS(Cont.)

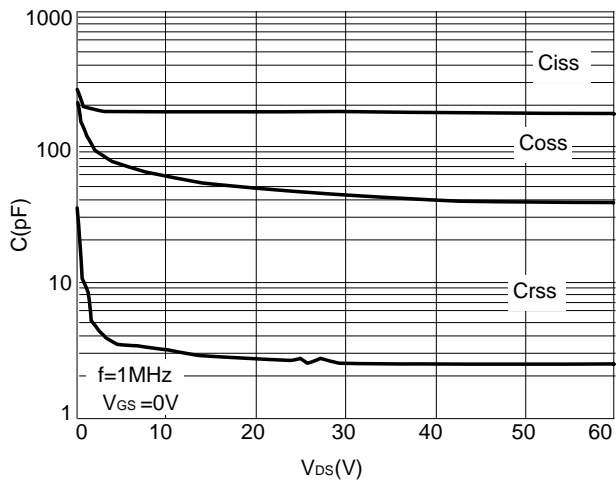


Figure 7: Capacitance vs. Drain-Source Voltage

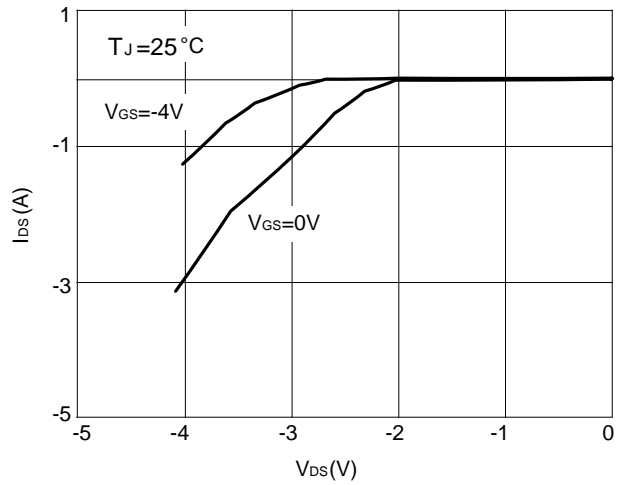


Figure 8: Body Diode Characteristics

■ TO-220F PACKAGE OUTLINE DIMENSIONS

